• MATERIALS: (RoHS Compliant)

Housing And Cover: Plastic Thermoplastic

L.C.P UL94V-0 Black

Contacts: Phosphor Bronze Gold

Selective Plated

Front Shell: Steel Nickel Plated

Over Copper

Bracket: Steel Nickel Plated

Over Copper

Boardlock: Brass Tin Plated

Over Copper

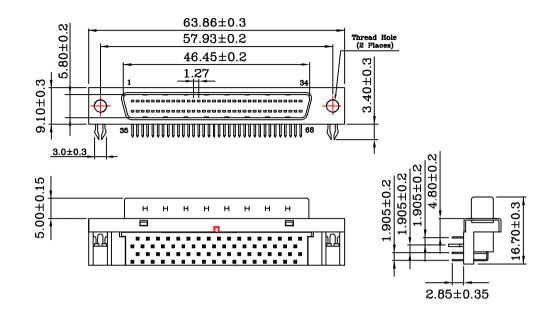
• ELECTRICAL CHARACTERISTICS:

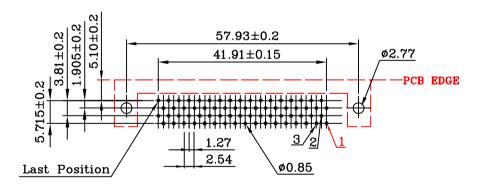
Contact Current Rating: 0.5 Amp Dielectric Withstanding Voltage: 500V AC

Insulation Resistance: $>500M\Omega$ /Min Contact Resistance: $35m\Omega$ /Max Operation Temperature: -55° C \sim $+85^{\circ}$ C

• SOLDER DIPPING:

260°C, 10 Seconds, or Twice 263°C, 5 Seconds, Up To Two Times (The preheat temperature is below 100°C component surfaces within 60 seconds)





PCB Layout (B)

